## SCI7660Coв/ Moв $_{\text {ов }}$

## DC-DC Converter



\author{

- 95\% Typical Power Efficiency <br> - Doubled or Output Voltage <br> - Voltage Conversion (Positive $\Leftrightarrow$ Negative)
}


## ■ DESCRIPTION

The SCI7660Сов/Мов CMOS DC-DC Converter features high operational performance with low power dissipation. The booster generates a doubled output voltage from the input.
It is possible to drive the LSI that need another power supply than main power supply. (LCD drivers•Analog LSI etc.) Its very low power requirement makes it ideal to supply handy equipments with power.

## ■ FEATURES

- High performance with low power dissipation
- Simple conversion of $\mathrm{VDD}(-5 \mathrm{~V})$ to $+\mathrm{VI}(+5 \mathrm{~V})$, $-2 \mathrm{VI}(-10 \mathrm{~V})$
- Output current $\qquad$ 30mA Max. (VDD = -5V)
- Power conversion efficiency 95\% Typ.
- Cascade connection
(two device connected VDD $=-5 \mathrm{~V}$, $\mathrm{Vo}=-15 \mathrm{~V}$ )
- Low power $\qquad$ Ideal for dry cell battery
- On-chip CR oscillator
- Package $\qquad$ DIP-8pin (plastic) SOP4-8pin (plastic)


## VOLTAGE RELATIONS



## PIN CONFIGURATION



PIN DESCRIPTION

| Pin Name | Pin No. | Function |
| :---: | :---: | :--- |
| OSC1 | 3 | Oscillation resister connection terminal |
| OSC2 | 2 |  |
| VDD | 4 | Power supply terminal (positive, system supply Vcc) |
| CAP1+ | 5 | Terminal for connection of capacitor for booster (positive) |
| CAP1- | 6 | Terminal for connection of capacitor for booster (negative) |
| Vo | 7 | Output terminal at doubling |
| VI | 8 | Power supply terminal (negative, system supply GND) |

## SCI7660Cob/Mов

ABSOLUTE MAXIMAM RATINGS
$\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Input voltage | $\mathrm{V} /$ | -10.0 to 0.5 | V |
| Output voltage | Vo | Min. -20.0 | V |
| Power dissipation | PD | 300 (DIP-8pin) $/ 150($ SOP4-8pin) | mW |
| Operating temperature | Topr | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | Tstg | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Soldering temperature and time | Tsol | $260^{\circ} \mathrm{C}, 10 \mathrm{~s}$ (at lead) | - |

Note: When this IC is soldered in the solder-reflow process, be sure to maintain the reflow furnace at the curve shown in "Fig. 3-5 Temperature Profile for Standard SMD Package (QFP, SOP, PLCC and etc.) of this DATA BOOK. And this IC can not be exposed to high temperature of the solder dipping.

■ ELECTRICAL CHARACTERISTICS

$$
\left(\mathrm{VI}=-5 \mathrm{~V}, \mathrm{Ta}=-40 \text { to } 85^{\circ} \mathrm{C}\right)
$$

| Characteristic | Symbol | Condition | Min. | Typ. | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Input voltage | VI |  | -8.0 | - | -1.5 | V |
| Output voltage | Vo |  | -16.0 | - | - | V |
| Booster current consumption | lopr | $\mathrm{RL}=\infty, \mathrm{ROSC}=1 \mathrm{M} \Omega, \mathrm{VI}=-5 \mathrm{~V}$ | - | 20 | 30 | $\mu \mathrm{~A}$ |
| Stationary current | IQ | $\mathrm{RL}=\infty, \mathrm{VI}=-8 \mathrm{~V}$ | - | - | 2.0 | $\mu \mathrm{~A}$ |
| Output impedamce | RO | $\mathrm{IO}=10 \mathrm{~mA}, \mathrm{VI}=-5 \mathrm{~V}$ | - | 75 | 100 | $\Omega$ |
| Booster power conversion efficiency | Peff | $\mathrm{IO}=5 \mathrm{~mA}, \mathrm{VI}=-5 \mathrm{~V}$ | 90 | 95 | - | $\%$ |
| Input leakage current | ILI | OSC 1 terminal, $\mathrm{VI}=-8 \mathrm{~V}$ | - | - | 2.0 | $\mu \mathrm{~A}$ |
| Oscillation frequency | fOSC | ROSC $=1 \mathrm{M} \Omega, \mathrm{VI}=-5 \mathrm{~V}$ | 16 | 20 | 24 | kHz |

■ RECOMMENDED OPERATING CONDITIONS
$\left(\mathrm{Ta}=-40\right.$ to $\left.85^{\circ} \mathrm{C}\right)$

| Condition | Symbol | Remark | Min. | Typ. | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Booster start voltage | VSTA1 | $\mathrm{ROSC}=1 \mathrm{M} \Omega, \mathrm{CL} / \mathrm{C} 2 \leq 1 / 20^{* 1}$ <br> $\mathrm{C} 2 \geq 10 \mu \mathrm{~F} T \mathrm{Ta}=-20$ to $85^{\circ} \mathrm{C}$ | - | - | -1.5 | V |
|  | VSTA 2 | $\mathrm{ROSC}=1 \mathrm{M} \Omega$ | - | - | -2.2 | V |
| Booster stop voltage | VSTP | $\mathrm{ROSC}=1 \mathrm{M} \Omega$ | -1.5 | - | - | V |
| Output load resistance | RL |  | RL Min. ${ }^{* 2}$ | - | - | $\Omega$ |
| Output current | IO |  | - | - | 30 | mA |
| Oscillation frequency | fosC |  | 10 | - | 30 | kHz |
| External resistance for oscillation | ROSC |  | 680 | - | 2000 | $\mathrm{k} \Omega$ |
| Capacitor for booster | $\mathrm{C} 1, \mathrm{C} 2, \mathrm{C} 3$ |  | 3.3 | - | - | $\mu \mathrm{F}$ |

Notes: *1: Recommended circuity in low voltage operation is shown below.
*2: RL Min. depends on input voltage as shown below.

Recommended circuit in low voltage operation


* $\mathrm{D} 1(\mathrm{VF}(\mathrm{IF}=1 \mathrm{~mA}) \leq 0.6 \mathrm{~V})$


## CIRCUIT DESCRIPTION

## - C-R Oscillator

The SCI7660Cob/Mob contains a C-R oscillator for internal oscillation. It consists of an external resistor Rosc connected between the OSC1 pin and OSC2 pin.

- Voltage Converters


The voltage converters double the input supply voltage (VI) using clocks generated by the C-R oscillator. A doubled voltage can be obtained with a booster capacitor between CAP+ and CAP-, and with a external smoothing capacitor between VI and Vo.


## SCI7660Cob/Mов

## BASIC EXTERNAL CONNECTION

- Parallel Connection (Output impedance can be reduced by parallel connections.)

- Positive Voltage Conversion (Input voltage can be doubled toward the positive side with diode.)

- Cascade Connection (Cascade Connection of SCI7660Cob/Mob further increase the output voltage.

Note, however, that the cascade connection increase the output impedance.)



Cascade Connection

- Negative Voltage Conversion + Positive Voltage Conversion (This circuit produces outputs of -10 V and +3.8 V from the -5 V input by combination of voltage doubler circuit and positive voltage conversion circuit.)


■ PACKAGE DIMENSIONS


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